SE20FD, SE20FG, SE20FJ

Vishay General Semiconductor

Surface-Mount Standard Rectifiers



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DESIGN SUPPORT TOOLS



PRIMARY CHARACTERISTICS							
I _{F(AV)}	2.0 A						
V _{RRM}	200 V, 400 V, 600 V						
I _{FSM}	35 A						
V_F at I_F = 2.0 A (T_A = 125 °C)	0.85 V						
I _R	5 μΑ						
T _J max.	175 °C						
Package	SMF (DO-219AB)						
Circuit configuration	Single						

FEATURES

- · Low profile package
- · Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop, low leakage current
- · ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Wave and reflow solderable
- AEC-Q101 qualified available - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

General purpose, power line polarity protection, in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: SMF (DO-219AB)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - for, halogen-free, and RoHS-compliant

Base P/NHM3 - for halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted)									
PARAMETER	SYMBOL	SE20FD	SE20FG	SE20FJ	UNIT				
Device marking code		CD	CG	CJ					
Maximum repetitive peak reverse voltage	ve peak reverse voltage V _{RRM} 200 400 600								
Maximum DC forward current	I _{F(AV)} ⁽¹⁾		А						
	I _{F(AV)} ⁽²⁾		A						
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}		А						
Operating junction and storage temperature range	T _J , T _{STG}		°C						

Notes

(1) Mounted on 10 mm x 10 mm pad areas, 2 oz. FR4 PCB

⁽²⁾ Free air, mounted on recommended copper pad area





RoHS COMPLIANT HALOGEN FREE





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ELECTRICAL CHARACTERISTICS ($T_A = 25$ °C unless otherwise noted)									
PARAMETER	TEST C	ONDITIONS	SYMBOL	TYP.	MAX.	UNIT			
Instantaneous forward voltage	I _F = 2.0 A	T _A = 25 °C	V _E (1)	0.96	1.10	V			
	$I_{\rm F} = 2.0 {\rm A}$	T _A = 125 °C	v F ()/	0.85	1.00				
Reverse current	Rated V _R	T _A = 25 °C	I _R ⁽²⁾	-	5	μA			
		T _A = 125 °C	IR (-/	7.6	100				
Typical reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		t _{rr}	920	-	ns			
Typical junction capacitance	4.0 V, 1 MHz		CJ	13	-	pF			

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: Pulse width \leq 40 ms

THERMAL CHARACTERISTICS ($T_A = 25$ °c unless otherwise noted)									
PARAMETER SYMBOL SE20FD SE20FG SE20FJ									
Typical thermal resistance	$R_{\theta JA}$ ⁽¹⁾		°C/W						
	R _{0JM} ⁽¹⁾		20		-0/00				

Note

⁽¹⁾ Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient; $R_{\theta JM}$ - junction to mount

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS (T _A = 25 °C unless otherwise noted)									
STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE				
AEC-Q101-001	Human body model (contact mode)	C = 100 pF, R = 1.5 k Ω	V _C	H3B	> 8 kV				

ORDERING INFORMATION (Example)									
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE					
SE20FJ-M3/H	0.015	Н	3000	7" diameter plastic tape and reel					
SE20FJ-M3/I	0.015	I	10 000	13" diameter plastic tape and reel					
SE20FJHM3/H ⁽¹⁾	0.015	н	3000	7" diameter plastic tape and reel					
SE20FJHM3/I ⁽¹⁾	0.015		10 000	13" diameter plastic tape and reel					

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES ($T_A = 25$ °C unless otherwise noted)

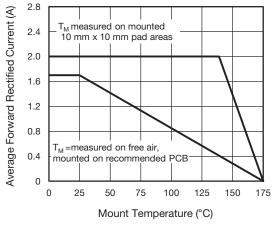
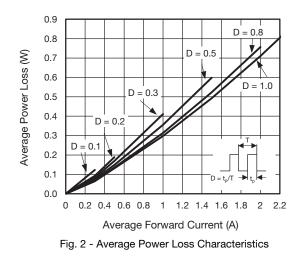


Fig. 1 - Maximum Forward Current Derating Curve



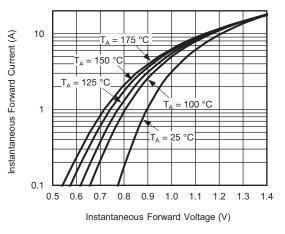


Fig. 3 - Typical Instantaneous Forward Characteristics

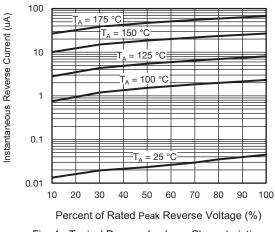


Fig. 4 - Typical Reverse Leakage Characteristics

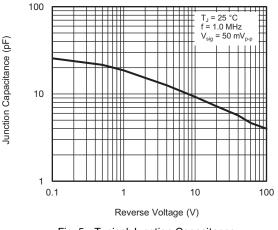


Fig. 5 - Typical Junction Capacitance

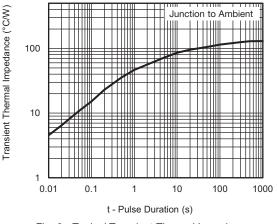


Fig. 6 - Typical Transient Thermal Impedance

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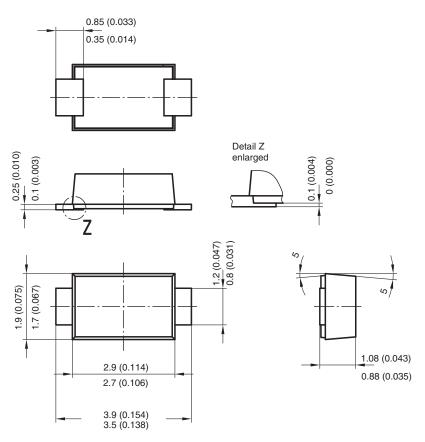
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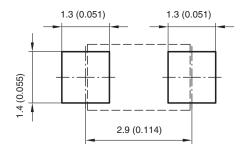


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PACKAGE OUTLINE DIMENSIONS in millimeters (inches)



Foot print recommendation:



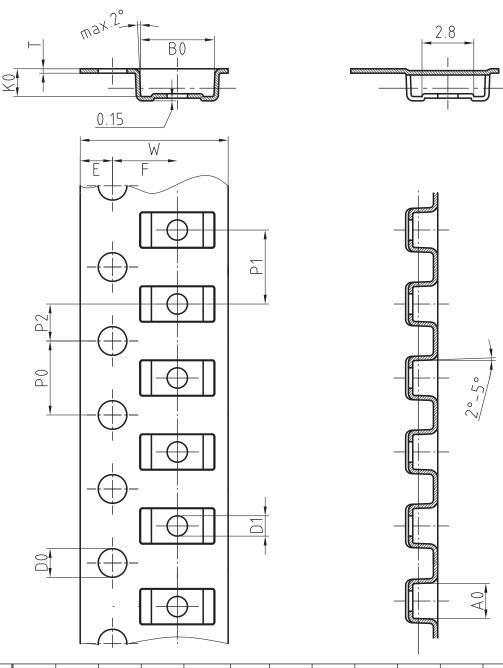
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BLISTERTAPE DIMENSIONS in millimeters: SMF (DO-219AB)



Mat	Α0	B0	K0	W	Т	P0	P2	P1	D0	D1	E	F
PS	1.9	4.0	1.5	8.0	0.235	4.0	2.0	4.0	1.5	1	1.75	3.5

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